



BGY587

550 MHz, 22 dB gain push-pull amplifier

Rev. 5 — 20 September 2011

Product data sheet

1. Product profile

1.1 General description

Hybrid amplifier module in a SOT115J package, operating at a supply voltage of 24 V. The BGY587 is intended for use as a final amplifier.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- TiPtAu metallized crystals ensure excellent reliability

1.3 Applications

- CATV systems operating in the 40 MHz to 550 MHz frequency range

1.4 Quick reference data

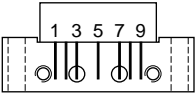
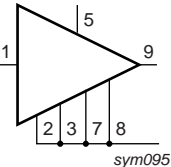
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$f = 50 \text{ MHz}$	21.5	-	22.5	dB
		$f = 550 \text{ MHz}$	22	-	-	dB
I_{tot}	total current consumption (DC)	$V_B = 24 \text{ V}$	^[1] -	220	240	mA

[1] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients of up to 30 V.



2. Pinning information

Table 2. Pinning		Simplified outline	Symbol
Pin	Description		
1	input		
2	common		
3	common		
5	+V _B		
7	common		
8	common		
9	output		

3. Ordering information

Table 3. Ordering information			
Type number	Package		
	Name	Description	Version
BGY587	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

4. Limiting values

Table 4. Limiting values					
In accordance with the Absolute Maximum Rating System (IEC 60134).					
Symbol	Parameter	Conditions	Min	Max	Unit
V _i	RF input voltage		-	65	dBmV
T _{stg}	storage temperature		-40	+100	°C
T _{mb}	mounting base temperature		-20	+100	°C

5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 550 MHz; $V_B = 24\text{ V}$; $T_{mb} = 30\text{ °C}$; $Z_S = Z_L = 75\ \Omega$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$f = 50\text{ MHz}$	21.5	-	22.5	dB
		$f = 550\text{ MHz}$	22	-	-	dB
SL	slope cable equivalent	$f = 40\text{ MHz to }550\text{ MHz}$	0.2	-	1.5	dB
FL	flatness of frequency response	$f = 40\text{ MHz to }550\text{ MHz}$	-	-	± 0.2	dB
S_{11}	input return losses	$f = 40\text{ MHz to }80\text{ MHz}$	20	-	-	dB
		$f = 80\text{ MHz to }160\text{ MHz}$	19	-	-	dB
		$f = 160\text{ MHz to }550\text{ MHz}$	18	-	-	dB
S_{22}	output return losses	$f = 40\text{ MHz to }80\text{ MHz}$	20	-	-	dB
		$f = 80\text{ MHz to }160\text{ MHz}$	19	-	-	dB
		$f = 160\text{ MHz to }550\text{ MHz}$	18	-	-	dB
φ_{s21}	phase response	$f = 50\text{ MHz}$	+135	-	+225	deg
CTB	composite triple beat	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 547.25 MHz	-	-	-57	dB
X_{mod}	cross modulation	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 55.25 MHz	-	-	-58	dB
CSO	composite second order distortion	77 channels flat; $V_o = 44\text{ dBmV}$; measured at 548.25 MHz	-	-	-54	dB
d_2	second order distortion		[1] -	-	-66	dB
V_o	output voltage	$d_{im} = -60\text{ dB}$	[2] 61	-	-	dBmV
NF	noise figure	$f = 550\text{ MHz}$	-	-	7	dB
I_{tot}	total current consumption (DC)		[3] -	220	240	mA

[1] $f_p = 55.25\text{ MHz}$; $V_p = 44\text{ dBmV}$; $f_q = 493.25\text{ MHz}$; $V_q = 44\text{ dBmV}$; measured at $f_p + f_q = 548.5\text{ MHz}$.

[2] Measured according to DIN45004B;

$f_p = 540.25\text{ MHz}$; $V_p = V_o$; $f_q = 547.25\text{ MHz}$; $V_q = V_o - 6\text{ dB}$; $f_r = 549.25\text{ MHz}$; $V_r = V_o - 6\text{ dB}$; measured at $f_p + f_q - f_r = 538.25\text{ MHz}$.

[3] The module normally operates at $V_B = 24\text{ V}$, but is able to withstand supply transients up to 30 V.

6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes;
 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

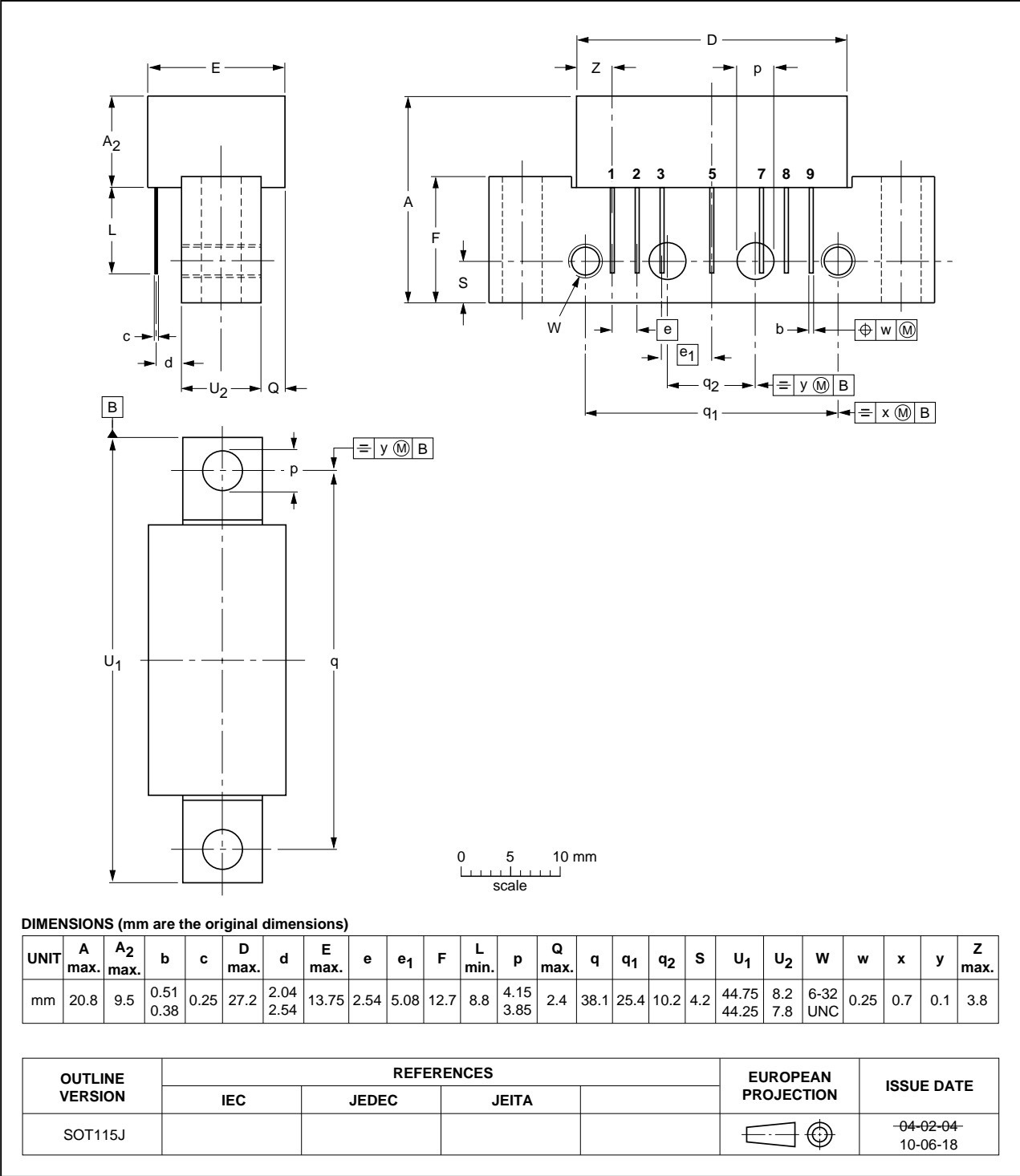


Fig 1. Package outline SOT115J

7. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY587 v.5	20110920	Product data sheet	-	BGY587 v.4
Modifications:	<ul style="list-style-type: none">• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.• Legal texts have been adapted to the new company name where appropriate.• Package outline drawings have been updated to the latest version.			
BGY587 v.4 (9397 750 14764)	20050411	Product data sheet	-	BGY587 v.3
BGY587 v.3 (9397 750 08966)	20011127	Product specification	-	BGY586 v.2
BGY586 v.2	19940207	n.a.	n.a.	-

8. Legal information

8.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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